

IN THE CLAIMS

Please amend the following claims:

3. (AMENDED) A liquid crystal panel according to Claim 1 [one of Claims 1 and 2], wherein the alignment layer is formed up to the region overlapping the region for forming the sealant in the sections corresponding to four sides of the substrate.

4. (AMENDED) A liquid crystal panel according to Claim 1 [any one of Claims 1 to 3], wherein the alignment layer is formed up to the edges of the substrate across the region for forming the sealant in the individual sides of the substrate excluding the side provided with input-output terminals and terminals for conducting between substrates.

5. (AMENDED) A liquid crystal panel according to Claim 1 [any one of Claims 1 to 4], wherein a transparent insulation film for covering the electrodes on the lower layer side of the alignment layer is formed in the region substantially overlapping the region for forming the alignment layer.

6. (AMENDED) A method of fabricating a liquid crystal panel defined in Claim 1 [any one of Claims 1 to 5], wherein the electrodes are formed on the surface of a large substrate for forming a plurality of pairs of substrates in the individual regions for forming the substrates which are divided by cutting the large substrate along cutting projection lines, and then thin films for forming the alignment layers are formed up to the regions for overlapping the regions for forming the sealant in the sections corresponding to at least three sides of the regions for forming the substrates.

9. (AMENDED) A method of fabricating a liquid crystal panel according to Claim 7 [one of Claims 7 and 8], wherein, in the large substrate, the substrate forming-

regions are placed with a cutting projection line therebetween so that the sides provided with input-output terminals and terminals for conducting between substrates are directed in the opposite directions, and when the thin films for forming the alignment layers are formed, the thin films are formed in [strip] ^Sstripe_A along the cutting projection line.

Please add the following new claims:

10. (NEW) A liquid crystal panel comprising:

a first substrate;

first electrodes formed on said first substrate;

a first alignment layer formed over said first electrodes;

a second substrate;

second electrodes formed on said second substrate;

a second alignment layer formed over said second electrodes;

a sealant coupled between said first and second substrates so as to form a gap therebetween, said sealant engaging said first and second alignment layers on at least three sides of said first and second substrates.

11. (NEW) The liquid crystal panel of Claim 10 wherein said first alignment layer is interposed between said sealant and said first substrate.

12. (NEW) The liquid crystal panel of Claim 10 wherein said second alignment layer is interposed between said sealant and said second substrate.

13. (NEW) The liquid crystal panel of Claim 10 wherein said first alignment layer

extends to a perimeter of said first substrate.

14. (NEW) The liquid crystal panel of Claim 10 wherein said second alignment layer extends to a perimeter of said second substrate.

15. (NEW) The liquid crystal panel of Claim 10 wherein a fourth side of said first and second substrates includes input-output terminals.

16. (NEW) The liquid crystal panel of Claim 10 further comprising:

a first transparent insulation film interposed between said first alignment layer and said first substrate over said first electrodes; and

a second transparent insulation film interposed between said second alignment layer and said second substrate over said second electrodes, said first and second transparent insulation films complimenting a configuration of said first and second alignment layers.

17. (NEW) A method of fabricating a liquid crystal panel comprising:

providing a first substrate;

defining a plurality of smaller substrate forming regions on said first substrate, said plurality of smaller substrate forming regions being divided by a plurality of projected cutting lines;

depositing electrodes on said first substrate within each of said smaller substrate forming regions;

defining a sealant deposit region along each of said smaller substrate forming regions; and

depositing a thin film for forming an alignment layer on said first substrate, said thin film engaging said sealant deposit region on at least three sides of each of said smaller substrate forming regions.

18. (NEW) The method of Claim 17 wherein said thin film is deposited so as to overlap said sealant deposit region along each of said smaller substrate forming regions.

19. (NEW) The method of Claim 17 wherein said thin film is deposited so as to overlap said plurality of projected cutting lines.

20. (NEW) The method of Claim 17 further comprising depositing a sealant on said sealant deposit region of each of said smaller substrate forming regions.

21. (NEW) The method of Claim 20 further comprising:

providing a second substrate;

defining a plurality of second smaller substrate forming regions on said second substrate, said plurality of second smaller substrate forming regions being divided by a plurality of second projected cutting lines;

depositing second electrodes on said second substrate within each of said second smaller substrate forming regions;

defining a second sealant deposit region along each of said second smaller substrate forming regions;

depositing a second thin film for forming a second alignment layer on said second substrate, said second thin film engaging said second sealant deposit region on at least